

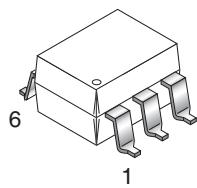
**H11AV1-M**

**H11AV1A-M**

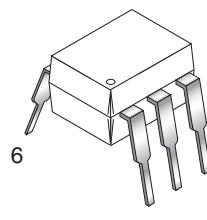
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**H11AV2A-M**

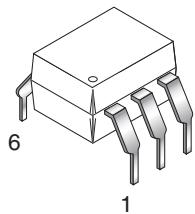
**PACKAGE OUTLINE**



H11AV1S-M, H11AV2S-M

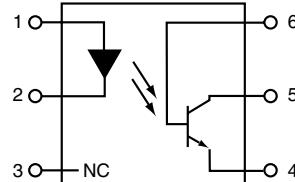


H11AV1-M, H11AV2-M



H11AV1A-M, H11AV2A-M

**SCHEMATIC**



PIN 1. ANODE  
2. CATHODE  
3. NO CONNECTION  
4. Emitter  
5. COLLECTOR  
6. BASE

**DESCRIPTION**

The general purpose optocouplers consist of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a 6-pin dual in-line white package.

**FEATURES**

- H11AV1 and H11AV2 feature 0.3" input-output lead spacing
- H11AV1A and H11AV2A feature 0.4" input-output lead spacing
- UL recognized (File #E90700, Vol. 2)
- VDE recognized (File #102497)
  - Add option V (e.g., H11AV1AV-M)

**APPLICATIONS**

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs

**H11AV1-M**
**H11AV1A-M**
**H11AV2-M**
**H11AV2A-M**
**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  unless otherwise specified)**

Parameter	Symbol	Value	Units
<b>TOTAL DEVICE</b>			
Storage Temperature	$T_{STG}$	-40 to +150	$^\circ\text{C}$
Operating Temperature	$T_{OPR}$	-40 to +100	$^\circ\text{C}$
Wave solder temperature (see page 9 for reflow solder profiles)	$T_{SOL}$	260 for 10 sec	$^\circ\text{C}$
Total Device Power Dissipation @ $T_A = 25^\circ\text{C}$	$P_D$	250	mW
Derate above $25^\circ\text{C}$		2.94	$\text{mW}/^\circ\text{C}$
<b>EMITTER</b>			
DC/Average Forward Input Current	$I_F$	60	mA
Reverse Input Voltage	$V_R$	6	V
LED Power Dissipation @ $T_A = 25^\circ\text{C}$	$P_D$	120	mW
Derate above $25^\circ\text{C}$		1.41	$\text{mW}/^\circ\text{C}$
<b>DETECTOR</b>			
Collector-Emitter Voltage	$V_{CEO}$	70	V
Collector-Base Voltage	$V_{CBO}$	70	V
Emitter-Collector Voltage	$V_{ECO}$	7	V
Detector Power Dissipation @ $T_A = 25^\circ\text{C}$	$P_D$	150	mW
Derate above $25^\circ\text{C}$		1.76	$\text{mW}/^\circ\text{C}$

**H11AV1-M**
**H11AV1A-M**
**H11AV2-M**
**H11AV2A-M**
**ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  unless otherwise specified)**
**INDIVIDUAL COMPONENT CHARACTERISTICS**

Parameter	Test Conditions	Symbol	Min	Typ*	Max	Unit
<b>EMITTER</b>						
Input Forward Voltage ( $I_F = 10 \text{ mA}$ )	$T_A = 25^\circ\text{C}$	$V_F$	0.8	1.18	1.5	V
	$T_A = -55^\circ\text{C}$		0.9	1.28	1.7	
	$T_A = 100^\circ\text{C}$		0.7	1.05	1.4	
Reverse Leakage Current	( $V_R = 6.0 \text{ V}$ )	$I_R$			10	$\mu\text{A}$
<b>DETECTOR</b>						
Collector-Emitter Breakdown Voltage	( $I_C = 1.0 \text{ mA}, I_F = 0$ )	$BV_{CEO}$	70	100		V
Collector-Base Breakdown Voltage	( $I_C = 100 \text{ } \mu\text{A}, I_F = 0$ )	$BV_{CBO}$	70	120		V
Emitter-Collector Breakdown Voltage	( $I_E = 100 \text{ } \mu\text{A}, I_F = 0$ )	$BV_{ECO}$	7	10		V
Collector-Emitter Dark Current	( $V_{CE} = 10 \text{ V}, I_F = 0$ )	$I_{CEO}$		1	50	nA
Collector-Base Dark Current	( $V_{CB} = 10 \text{ V}$ )	$I_{CBO}$		0.5		nA
Capacitance	( $V_{CE} = 0 \text{ V}, f = 1 \text{ MHz}$ )	$C_{CE}$		8		pF

**ISOLATION CHARACTERISTICS**

Characteristic	Test Conditions	Symbol	Min	Typ*	Max	Units
Input-Output Isolation Voltage	( $f = 60 \text{ Hz}, t = 1 \text{ sec}$ )	$V_{ISO}$	7500			Vac(pk)
Isolation Resistance	( $V_{I-O} = 500 \text{ VDC}$ )	$R_{ISO}$	$10^{11}$			$\Omega$
Isolation Capacitance	( $V_{I-O} = 0 \text{ V}, f = 1 \text{ MHz}$ )	$C_{ISO}$		0.2	2	pF

Note

 \* Typical values at  $T_A = 25^\circ\text{C}$

**H11AV1-M**

**H11AV1A-M**

**H11AV2-M**

**H11AV2A-M**

**TRANSFER CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  Unless otherwise specified.)**

DC Characteristic	Test Conditions	Symbol	Device	Min	Typ*	Max	Unit
Current Transfer Ratio, Collector to Emitter	$(I_F = 10 \text{ mA}, V_{CE} = 10 \text{ V})$	CTR	H11AV1 H11AV1A	100		300	%
			H11AV2 H11AV2A	50			
Collector-Emitter Saturation Voltage	$(I_C = 2 \text{ mA}, I_F = 20 \text{ mA})$	$V_{CE(\text{SAT})}$	All			0.4	V
<b>AC Characteristic</b>							
Non-Saturated Turn-on Time	$(I_C = 2 \text{ mA}, V_{CC} = 10 \text{ V}, R_L = 100\Omega)$ (Fig. 11)	$T_{ON}$	All			15	$\mu\text{s}$
Non Saturated Turn-off Time	$(I_C = 2 \text{ mA}, V_{CC} = 10 \text{ V}, R_L = 100\Omega)$ (Fig. 11)	$T_{ON}$	All			15	$\mu\text{s}$

\* Typical values at  $T_A = 25^\circ\text{C}$

**H11AV1-M**

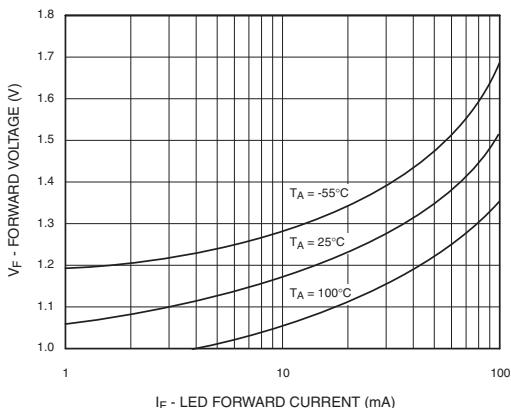
**H11AV1A-M**

**H11AV2-M**

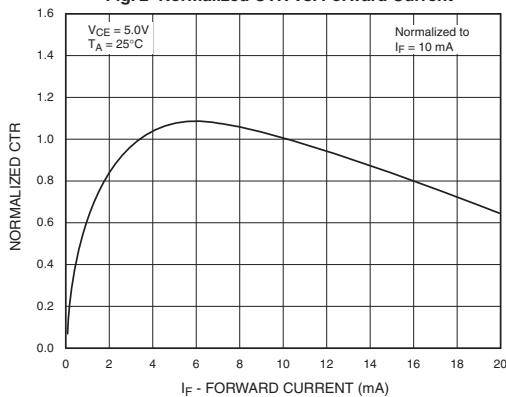
**H11AV2A-M**

## TYPICAL PERFORMANCE CURVES

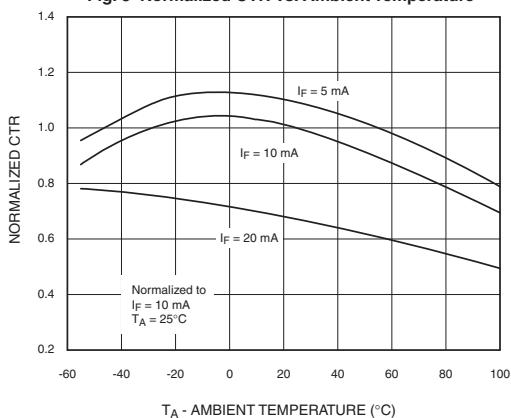
**Fig. 1 LED Forward Voltage vs. Forward Current**



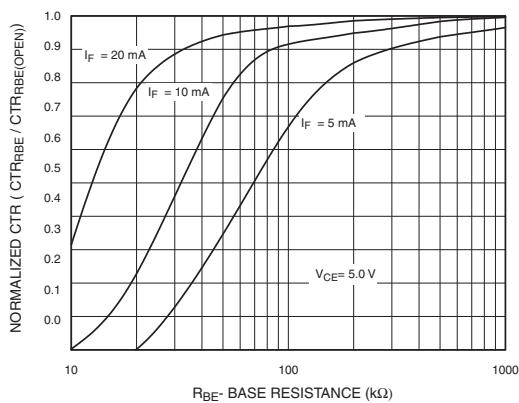
**Fig. 2 Normalized CTR vs. Forward Current**



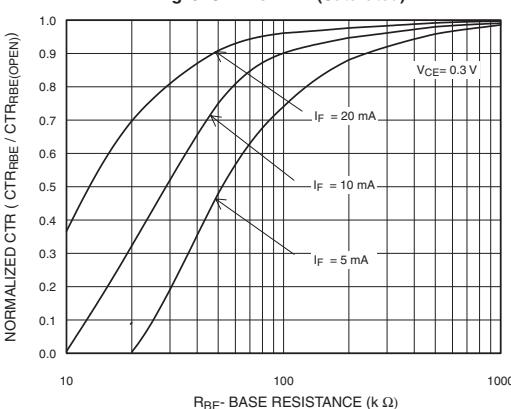
**Fig. 3 Normalized CTR vs. Ambient Temperature**



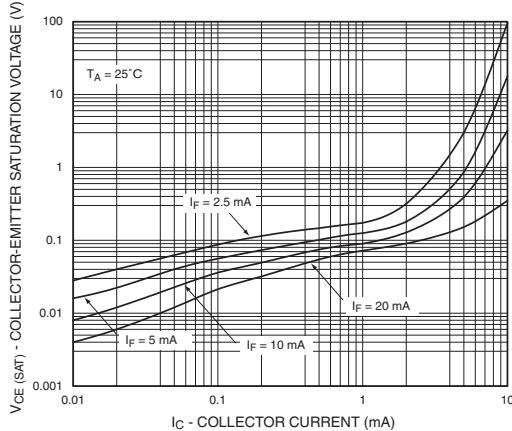
**Fig. 4 CTR vs. R<sub>BE</sub> (Unsaturated)**



**Fig. 5 CTR vs. R<sub>BE</sub> (Saturated)**



**Fig. 6 Collector-Emitter Saturation Voltage vs Collector Current**



**H11AV1-M**

**H11AV1A-M**

**H11AV2-M**

**H11AV2A-M**

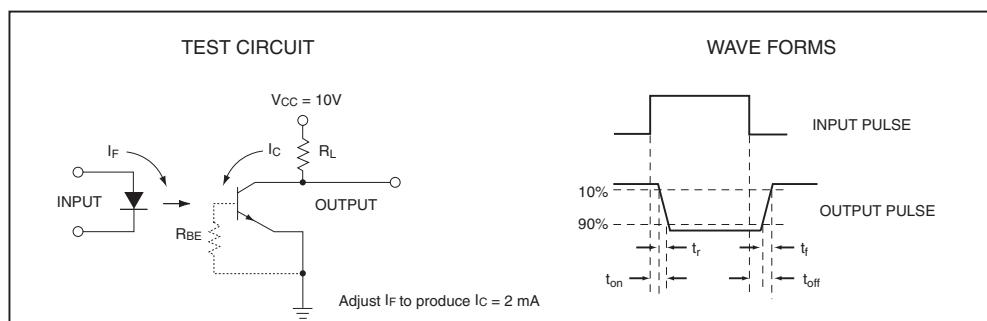
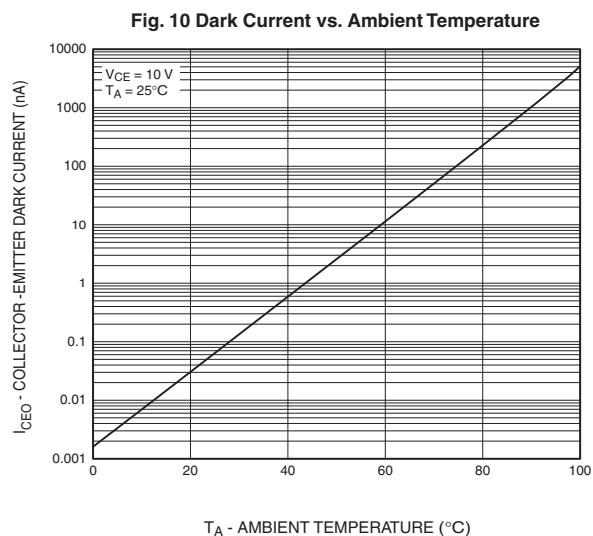
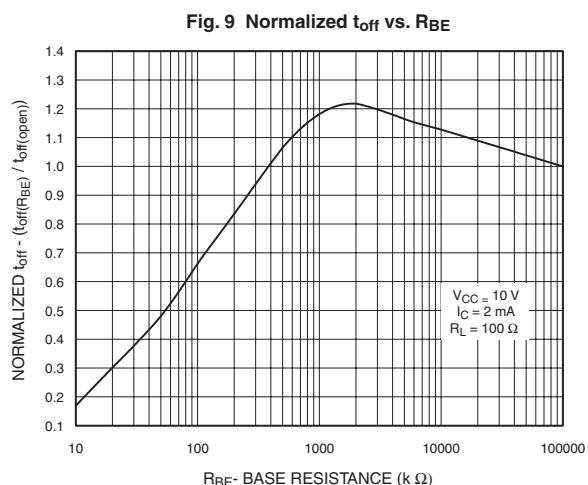
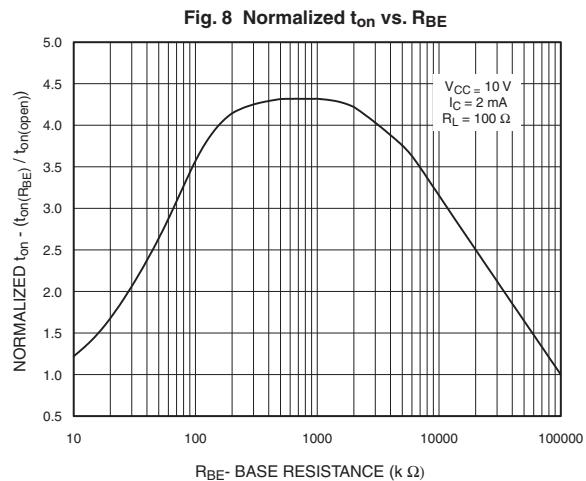
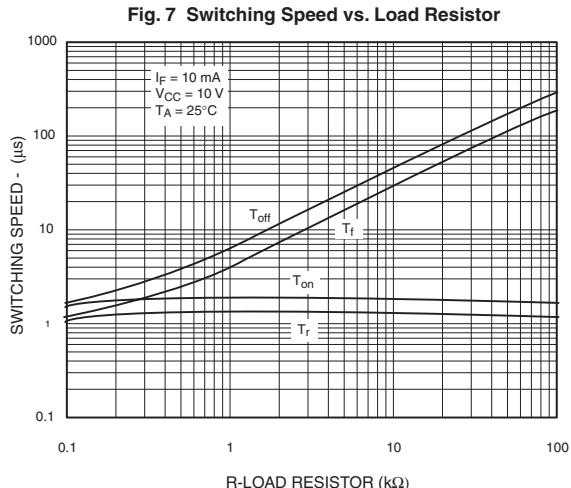


Figure 11. Switching Time Test Circuit and Waveforms

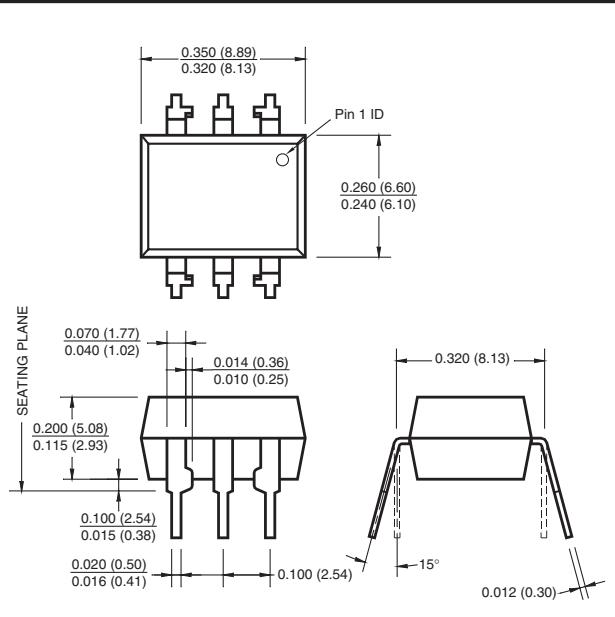
H11AV1-M

H11AV1A-M

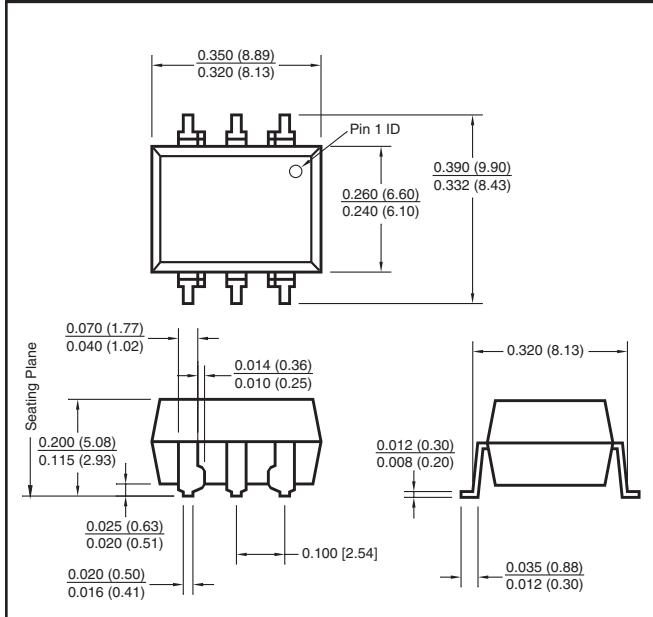
H11AV2-M

H11AV2A-M

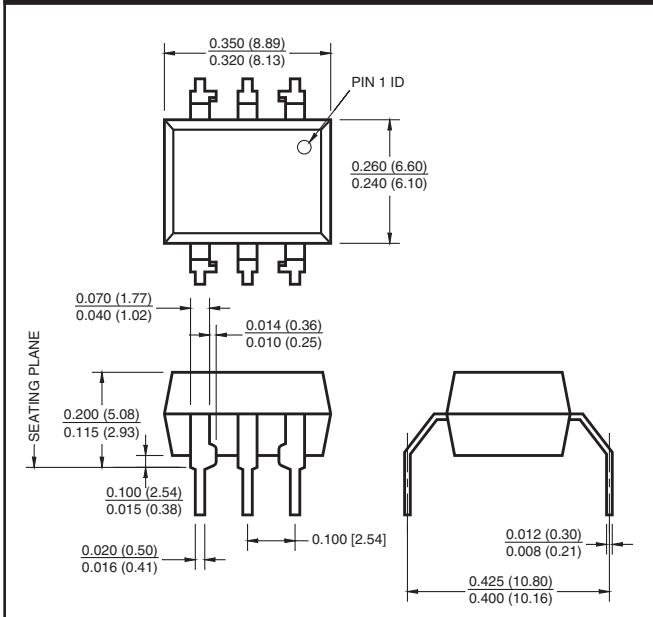
## Package Dimensions (Through Hole)



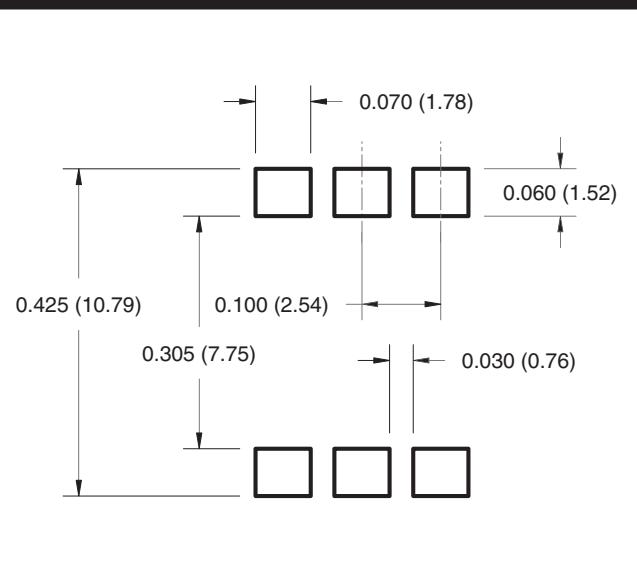
## Package Dimensions (Surface Mount)



## Package Dimensions (0.4" Lead Spacing)



## **Recommended Pad Layout for Surface Mount Leadform**



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**NOTE**

All dimensions are in inches (millimeters)

**H11AV1-M**

**H11AV1A-M**

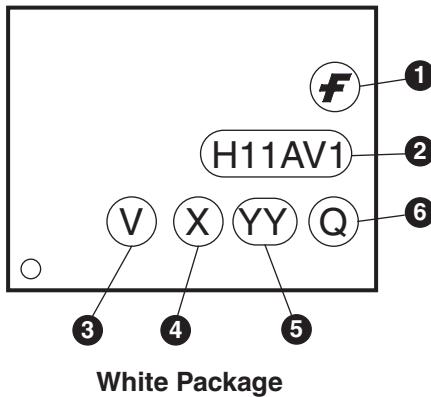
**H11AV2-M**

**H11AV2A-M**

### ORDERING INFORMATION

<b>Order Entry Identifier</b>		
<b>Order Entry Identifier</b>	<b>Option</b>	<b>Example</b>
S	Surface Mount Lead Bend	H11AV1S-M
SR2	Surface Mount; Tape and reel	H11AV1SR2-M
N/A	0.4" Lead Spacing	H11AV1A-M
V	VDE 0884	H11AV1V-M
N/A	VDE 0884, 0.4" Lead Spacing	H11AV1AV-M
SV	VDE 0884, Surface Mount	H11AV1SV-M
SR2V	VDE 0884, Surface Mount, Tape & Reel	H11AV1SR2V-M

### MARKING INFORMATION



<b>Definitions</b>	
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One digit year code • One digit for white package parts, e.g., '3'
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

\*Note – Parts built in the white package (M suffix) that do not have the 'V' option (see definition 3 above) that are marked with date code '325' or earlier are marked in the portrait format.

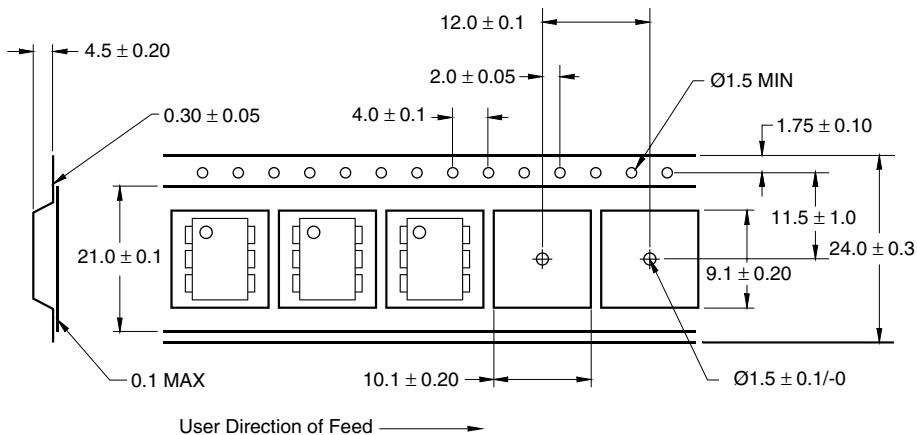
**H11AV1-M**

H11AV1A-M

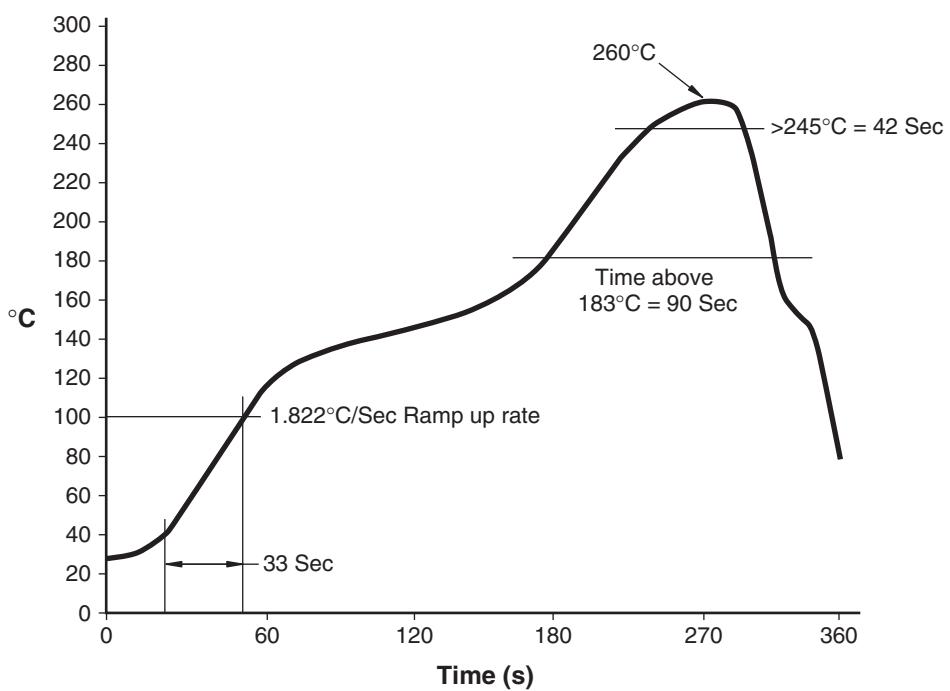
H11AV2-M

H11AV2A-M

## **Carrier Tape Specifications**



## Reflow Profile





# PHOTOTRANSISTOR OPTOCOUPERS

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**H11AV1-M****H11AV1A-M****H11AV2-M****H11AV2A-M**

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ООО "ЛайфЭлектроникс"

"LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

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- Изготовление тестовой платы монтаж и пусконаладочные работы.



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